

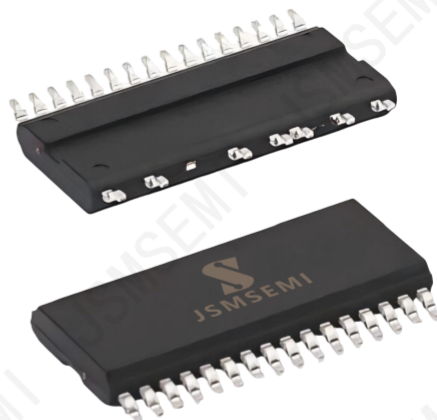
## General Description

IRSM515-055 is a highly integrated and highly reliable three-phase brushless DC motor drive circuit, primarily

used for driving low-power motors such as fans. It incorporates six fast recovery power MOSFETs and three half-bridge high-voltage gate drive circuits.

The IRSM515-055 integrates an undervoltage protection function internally, providing excellent protection and fail-safe operation. Since each phase has an independent negative DC terminal, its current can be detected separately.

IRSM515-055 features a design that is highly insulated, easily thermally conductive, and low in electromagnetic interference. It offers a very compact package, making it highly convenient to use, especially suitable for applications built into motors and situations requiring compact installation.



- Isolation Rating: 1500 V<sub>rms</sub> / min.
- Moisture Sensitive Level (MSL) 3
- RoHS Compliant

## Features

- 500V R<sub>DS(on)</sub> = 1.5Ω(Max) FRFET MOSFET 3-Phase Inverter with Gate Drivers and Protection
- Built-In Bootstrap Diodes Simplify PCB Layout
- Separate Open-Source Pins from Low-Side MOSFETs for Three-Phase Current-Sensing
- Active-HIGH Interface, Works with 3.3/5V Logic, Schmitt-trigger Input
- Optimized for Low Electromagnetic Interference
- HVIC for Gate Driving and Under-Voltage Protection

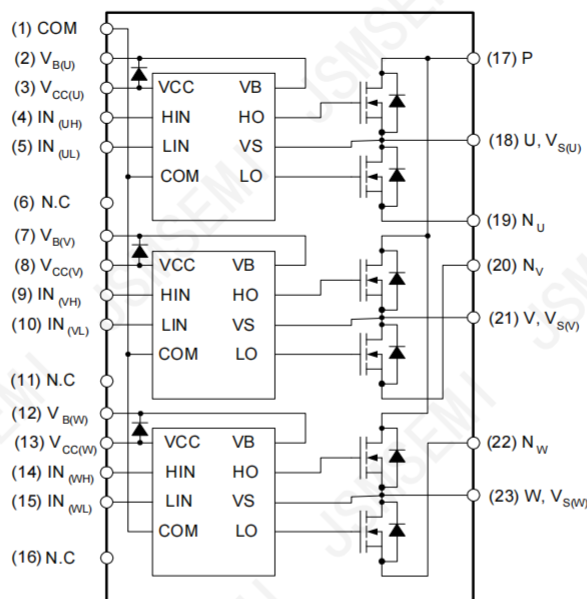
## Applications

- 3-Phase Inverter Driver for Small Power AC Motor Drives
- Indoor/outdoor air conditioning
- Refrigerator compressor
- Exhaust fan
- Fan
- Air purifier
- Dishwasher water pump

## Ordering Information

| Order number        | Package | Marking     | Operation Temperature Range | MSL Grade | Ship,Quantity | Green |
|---------------------|---------|-------------|-----------------------------|-----------|---------------|-------|
| IRSM515-055PATR-JSM | SOP-23H | JSM05M50TBS | -40 to 150°C                | 3         | T&R,700       | RoHS  |

## Pin descriptions



**Figure 1. Pin Configuration and Internal Block Diagram (Bottom View)**

| Pin Number | Pin Name      | Pin Description                                                       |
|------------|---------------|-----------------------------------------------------------------------|
| 1          | COM           | IC Common Supply Ground                                               |
| 2          | $V_{B(U)}$    | Bias Voltage for U-Phase High-Side MOSFET Driving                     |
| 3          | $V_{CC(U)}$   | Bias Voltage for U-Phase IC and Low-Side MOSFET Driving               |
| 4          | $IN_{(UH)}$   | Signal Input for U-Phase High-Side                                    |
| 5          | $IN_{(UL)}$   | Signal Input for U-Phase Low-Side                                     |
| 6          | N.C           | No Connection                                                         |
| 7          | $V_{B(V)}$    | Bias Voltage for V-Phase High Side MOSFET Driving                     |
| 8          | $V_{CC(V)}$   | Bias Voltage for V-Phase IC and Low Side MOSFET Driving               |
| 9          | $IN_{(VH)}$   | Signal Input for V-Phase High-Side                                    |
| 10         | $IN_{(VL)}$   | Signal Input for V-Phase Low-Side                                     |
| 11         | N.C           | No Connection                                                         |
| 12         | $V_{B(W)}$    | Bias Voltage for W-Phase High-Side MOSFET Driving                     |
| 13         | $V_{CC(W)}$   | Bias Voltage for W-Phase IC and Low-Side MOSFET Driving               |
| 14         | $IN_{(WH)}$   | Signal Input for W-Phase High-Side                                    |
| 15         | $IN_{(WL)}$   | Signal Input for W-Phase Low-Side                                     |
| 16         | N.C           | No Connection                                                         |
| 17         | P             | Positive DC-Link Input                                                |
| 18         | U, $V_{S(U)}$ | Output for U-Phase & Bias Voltage Ground for High-Side MOSFET Driving |
| 19         | $N_U$         | Negative DC-Link Input for U-Phase                                    |
| 20         | $N_V$         | Negative DC-Link Input for V-Phase                                    |
| 21         | V, $V_{S(V)}$ | Output for V-Phase & Bias Voltage Ground for High-Side MOSFET Driving |
| 22         | $N_W$         | Negative DC-Link Input for W-Phase                                    |
| 23         | W, $V_{S(W)}$ | Output for W Phase & Bias Voltage Ground for High-Side MOSFET Driving |



## Absolute Maximum Ratings

Exceeding the limit maximum rating may cause permanent damage to the device. All voltage parameters are rated with reference to COM and an ambient temperature of 25°C.

**Inverter Part** (each MOSFET unless otherwise specified.)

| Symbol       | Parameter                             | Conditions                                            | Rating | Unit             |
|--------------|---------------------------------------|-------------------------------------------------------|--------|------------------|
| $V_{DSS}$    | Drain-Source Voltage of Each MOSFET   |                                                       | 500    | V                |
| $*I_{D\ 25}$ | Each MOSFET Drain Current, Continuous | $T_C = 25^\circ\text{C}$                              | 7.0    | A                |
| $*I_{D\ 80}$ | Each MOSFET Drain Current, Continuous | $T_C = 80^\circ\text{C}$                              | 5.0    | A                |
| $*I_{DP}$    | Each MOSFET Drain Current, Peak       | $T_C = 25^\circ\text{C}$ , $PW < 100\ \mu\text{s}$    | 18.0   | A                |
| $*I_{DRMS}$  | Each MOSFET Drain Current, Rms        | $T_C = 80^\circ\text{C}$ , $F_{PWM} < 20\ \text{kHz}$ | 7.5    | A <sub>rms</sub> |
| $*P_D$       | Maximum Power Dissipation             | $T_C = 25^\circ\text{C}$ , For Each MOSFET            | 20     | W                |

**Control Part** (each HVIC unless otherwise specified.)

| Symbol   | Parameter              | Conditions                       | Rating                   | Unit |
|----------|------------------------|----------------------------------|--------------------------|------|
| $V_{CC}$ | Control Supply Voltage | Applied between $V_{CC}$ and COM | 20                       | V    |
| $V_{BS}$ | High-side Bias Voltage | Applied between $V_B$ and $V_S$  | 20                       | V    |
| $V_{IN}$ | Input Signal Voltage   | Applied between $V_{IN}$ and COM | $-0.3 \sim V_{CC} + 0.3$ | V    |

**Bootstrap Diode Part** (each bootstrap diode unless otherwise specified.)

| Symbol     | Parameter                          | Conditions                                       | Rating | Unit |
|------------|------------------------------------|--------------------------------------------------|--------|------|
| $V_{RRMB}$ | Maximum Repetitive Reverse Voltage |                                                  | 500    | V    |
| $*I_{FB}$  | Forward Current                    | $T_C = 25^\circ\text{C}$                         | 0.25   | A    |
| $*I_{FPB}$ | Forward Current (Peak)             | $T_C = 25^\circ\text{C}$ , Under 1ms Pulse Width | 0.5    | A    |

## Thermal Resistance

| Symbol          | Parameter                           | Conditions                                     | Rating | Unit               |
|-----------------|-------------------------------------|------------------------------------------------|--------|--------------------|
| $R_{\theta JC}$ | Junction to Case Thermal Resistance | Each MOSFET under Inverter Operating Condition | 7.0    | $^\circ\text{C/W}$ |

## Total System

| Symbol    | Parameter                      | Conditions                                                   | Rating         | Unit             |
|-----------|--------------------------------|--------------------------------------------------------------|----------------|------------------|
| $T_J$     | Operating Junction Temperature |                                                              | $-40 \sim 150$ | $^\circ\text{C}$ |
| $T_{STG}$ | Storage Temperature            |                                                              | $-40 \sim 150$ | $^\circ\text{C}$ |
| $V_{ISO}$ | Isolation Voltage              | 60 Hz, Sinusoidal, 1 Minute, Connect Pins to Heat Sink Plate | 1500           | $V_{rms}$        |

## Recommended Operating Condition

| Symbol        | Parameter                              | Conditions                                                                  | Min. | Typ. | Max.     | Unit          |
|---------------|----------------------------------------|-----------------------------------------------------------------------------|------|------|----------|---------------|
| $V_{PN}$      | Supply Voltage                         | Applied between P and N                                                     | -    | 300  | 400      | V             |
| $V_{CC}$      | Control Supply Voltage                 | Applied between $V_{CC}$ and COM                                            | 10.0 |      | 18.0     | V             |
| $V_{BS}$      | High-Side Bias Voltage                 | Applied between $V_B$ and $V_S$                                             | 10.0 |      | 18.0     | V             |
| $V_{IN(ON)}$  | Input ON Threshold Voltage             | Applied between $V_{IN}$ and COM                                            | 3.0  | -    | $V_{CC}$ | V             |
| $V_{IN(OFF)}$ | Input OFF Threshold Voltage            |                                                                             | 0    | -    | 0.6      | V             |
| $t_{dead}$    | Blanking Time for Preventing Arm-Short | $V_{CC} = V_{BS} = 13.5 \sim 16.5\ \text{V}$ , $T_J \leq 150^\circ\text{C}$ | 1.0  | -    | -        | $\mu\text{s}$ |
| $f_{PWM}$     | PWM Switching Frequency                | $T_J \leq 150^\circ\text{C}$                                                | -    | 15   | -        | kHz           |



**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$ ,  $V_{CC} = V_{BS} = 15\text{ V}$  unless otherwise specified.)

**Inverter Part** (each MOSFET unless otherwise specified.)

| Symbol       | Parameter                                | Conditions                                                                                                                                                                                                     | Min         | Typ | Max | Unit          |
|--------------|------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------|-----|-----|---------------|
| $BV_{DSS}$   | Drain - Source Breakdown Voltage         | $V_{IN} = 0\text{ V}$ , $I_D = 1\text{ mA}$ (2nd Note 1)                                                                                                                                                       | 500         | -   | -   | V             |
| $I_{DSS}$    | Zero Gate Voltage Drain Current          | $V_{IN} = 0\text{ V}$ , $V_{DS} = 500\text{ V}$                                                                                                                                                                | -           | -   | 1   | mA            |
| $R_{DS(on)}$ | Static Drain - Source Turn-On Resistance | $V_{CC} = V_{BS} = 15\text{ V}$ , $V_{IN} = 5\text{ V}$ , $I_D = 2.5\text{ A}$                                                                                                                                 | -           | 1.0 | 1.5 | $\Omega$      |
| $V_{SD}$     | Drain - Source Diode Forward Voltage     | $V_{CC} = V_{BS} = 15\text{ V}$ , $V_{IN} = 0\text{ V}$ , $I_D = -5.0\text{ A}$                                                                                                                                | -           | -   | 1.4 | V             |
| $t_{ON}$     | Switching Times                          | $V_{PN} = 300\text{ V}$ , $V_{CC} = V_{BS} = 15\text{ V}$ , $I_D = 0.5\text{ A}$<br>$V_{IN} = 0\text{ V} \leftrightarrow 5\text{ V}$ , Inductive Load $L = 3\text{ mH}$<br>High- and Low-Side MOSFET Switching | -           | 960 | -   | ns            |
| $t_{OFF}$    |                                          |                                                                                                                                                                                                                | -           | 760 | -   | ns            |
| $t_{rr}$     |                                          |                                                                                                                                                                                                                | -           | 140 | -   | ns            |
| $E_{ON}$     |                                          |                                                                                                                                                                                                                | -           | 300 | -   | $\mu\text{J}$ |
| $E_{OFF}$    |                                          |                                                                                                                                                                                                                | -           | 20  | -   | $\mu\text{J}$ |
| RBSOA        | Reverse Bias Safe Operating Area         | $V_{PN} = 400\text{ V}$ , $V_{CC} = V_{BS} = 15\text{ V}$ , $I_D = I_{DP}$ , $V_{DS} = BV_{DSS}$ ,<br>$T_J = 150^\circ\text{C}$<br>High- and Low-Side MOSFET Switching                                         | Full Square |     |     |               |

**Control Part** (each HVIC unless otherwise specified.)

| Symbol     | Parameter                               | Conditions                                                                                                            | Min | Typ | Max | Unit          |
|------------|-----------------------------------------|-----------------------------------------------------------------------------------------------------------------------|-----|-----|-----|---------------|
| $I_{QCC}$  | Quiescent $V_{CC}$ Current              | $V_{CC} = 15\text{ V}$ ,<br>$V_{IN} = 0\text{ V}$ Applied between $V_{CC}$ and COM                                    | -   | -   | 220 | $\mu\text{A}$ |
| $I_{QBS}$  | Quiescent $V_{BS}$ Current              | $V_{BS} = 15\text{ V}$ ,<br>$V_{IN} = 0\text{ V}$ Applied between $V_{B(U)} - U$ ,<br>$V_{B(V)} - V$ , $V_{B(W)} - W$ | -   | -   | 100 | $\mu\text{A}$ |
| $UV_{CCD}$ | Low-Side Under-Voltage Protection       | $V_{CC}$ Under-Voltage Protection Detection Level                                                                     | -   | 7.7 | -   | V             |
| $UV_{CCR}$ |                                         | $V_{CC}$ Under-Voltage Protection Reset Level                                                                         | -   | 8.7 | -   | V             |
| $UV_{BSD}$ | High-Side Under-Voltage Protection      | $V_{BS}$ Under-Voltage Protection Detection Level                                                                     | -   | 7.7 | -   | V             |
| $UV_{BSR}$ |                                         | $V_{BS}$ Under-Voltage Protection Reset Level                                                                         | -   | 8.7 | -   | V             |
| $V_{TS}$   | HVIC Temperature Sensing Voltage Output | $V_{CC} = 15\text{ V}$ , $T_{HVIC} = 25^\circ\text{C}$                                                                | 300 | 600 | 900 | mV            |
| $V_{IH}$   | ON Threshold Voltage                    | Logic HIGH Level                                                                                                      | -   | -   | 2.5 | V             |
| $V_{IL}$   | OFF Threshold Voltage                   | Logic LOW Level                                                                                                       | 0.8 | -   | -   | V             |

**Bootstrap Diode Part** (each bootstrap diode unless otherwise specified.)

| Symbol   | Parameter                     | Conditions                                      | Min | Typ | Max | Unit |
|----------|-------------------------------|-------------------------------------------------|-----|-----|-----|------|
| $V_{FB}$ | Forward Voltage               | $I_F = 0.1\text{ A}$ , $T_C = 25^\circ\text{C}$ | -   | 2.7 | -   | V    |
| $t_{rB}$ | Reverse Recovery Time         | $I_F = 0.1\text{ A}$ , $T_C = 25^\circ\text{C}$ | -   | 80  | -   | ns   |
| RBSD     | BSD Current Limiting Resistor |                                                 | -   | 200 | -   | ohm  |

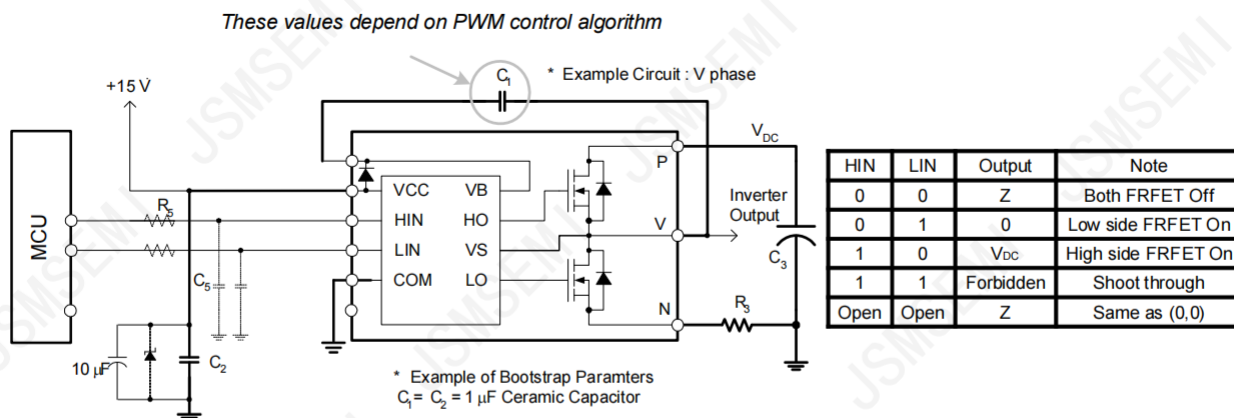


Figure 2. Recommended MCU Interface and Bootstrap Circuit with Parameters

**Notes:**

- Parameters for bootstrap circuit elements are dependent on PWM algorithm. For 15 kHz of switching frequency, typical example of parameters is shown above.
- RC-coupling ( $R_5$  and  $C_5$ ) and  $C_4$  at each input of JSMSEMI IPM product and MCU (Indicated as Dotted Lines) may be used to prevent improper signal due to surge-noise.
- Bold lines should be short and thick in PCB pattern to have small stray inductance of circuit, which results in the reduction of surge-voltage. Bypass capacitors such as  $C_1$ ,  $C_2$  and  $C_3$  should have good high-frequency characteristics to absorb high-frequency ripple-current.

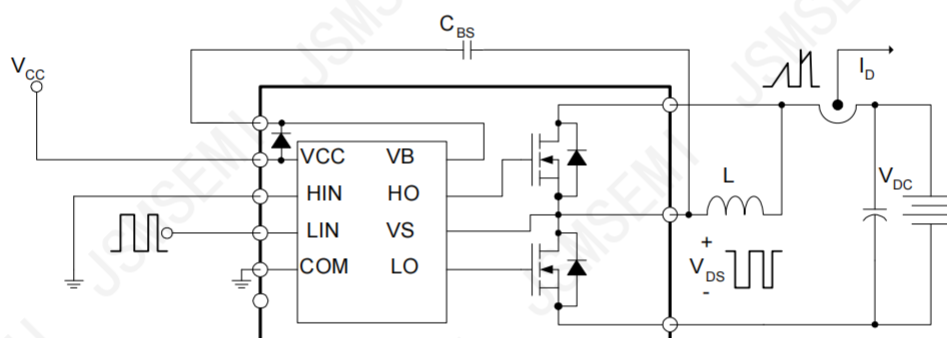


Figure 3. Switching and RBSOA (Single-Pulse) Test Circuit (Low-side)

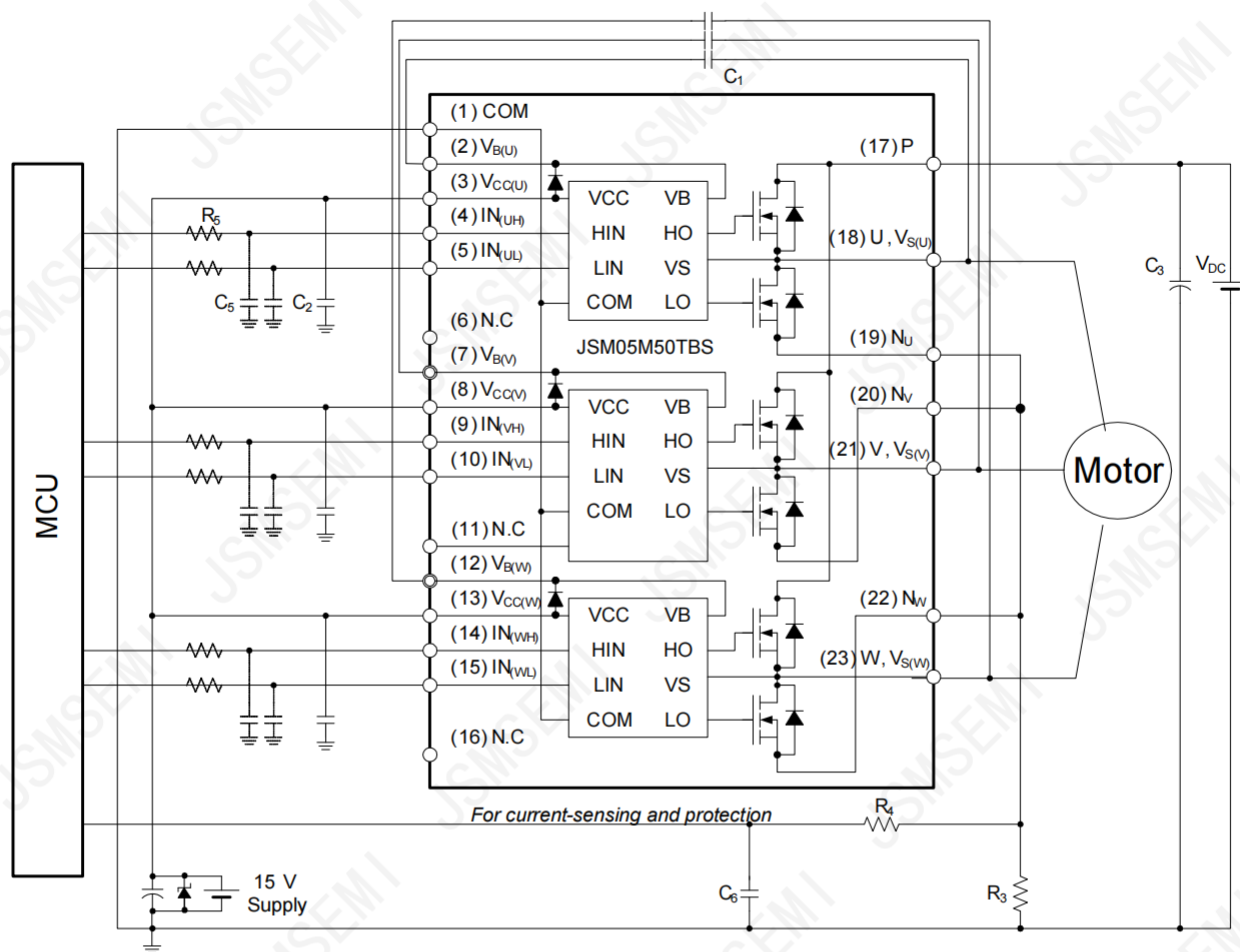


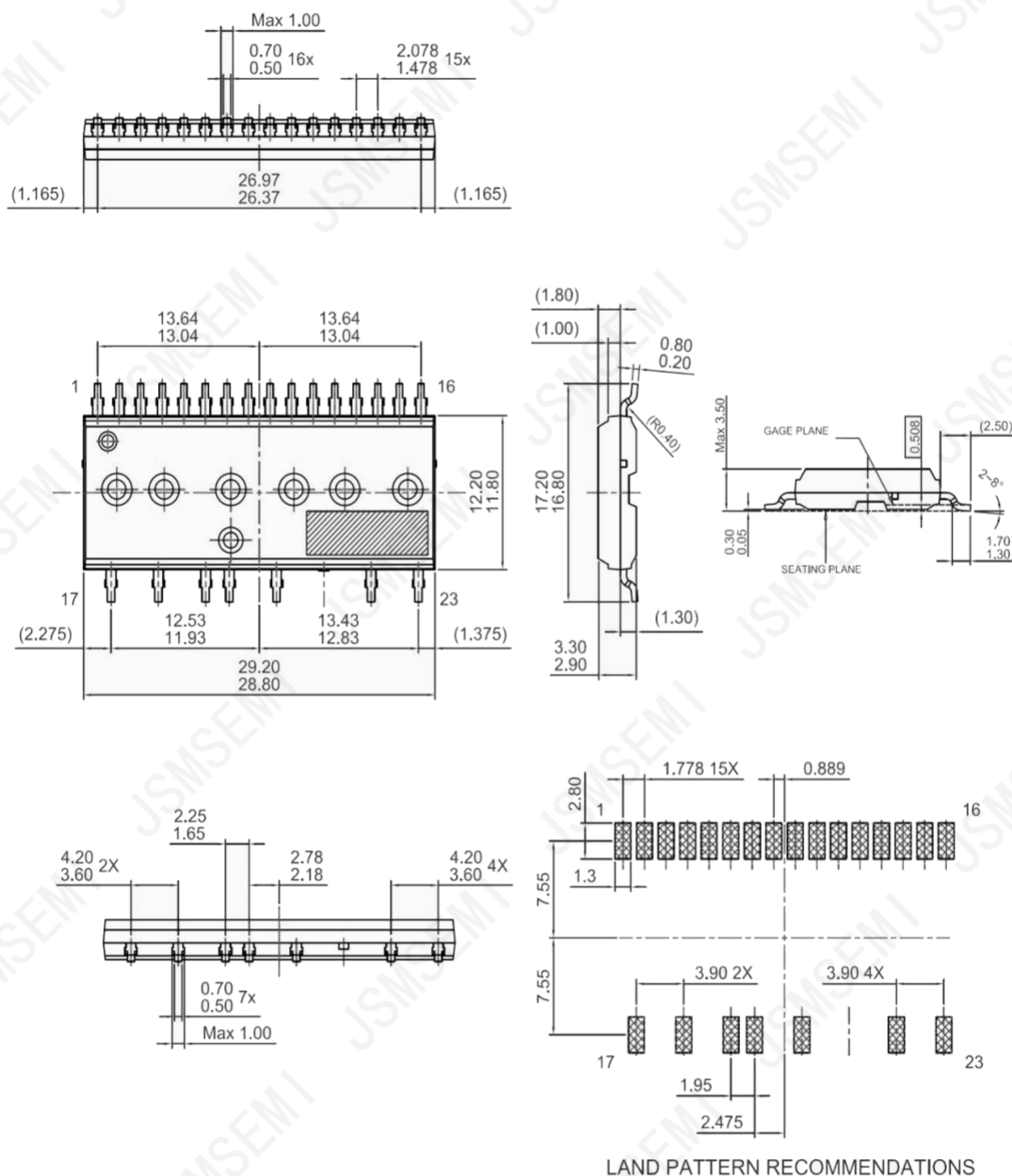
Figure 5. Example of Application Circuit

**Notes:**

1. About pin position, refer to Figure 1.
2. RC-coupling (R<sub>5</sub> and C<sub>5</sub>, R<sub>4</sub> and C<sub>6</sub>) and C<sub>4</sub> at each input of JSMSEMI IPM and MCU are useful to prevent improper input signal caused by surge-noise.
3. The voltage-drop across R<sub>3</sub> affects the lowside switching performance and the bootstrap characteristics since it is placed between COM and the source terminal of the low-side MOSFET. For this reason, the voltage-drop across R<sub>3</sub> should be less than 1 V in the steady-state.
4. Ground-wires and output terminals, should be thick and short in order to avoid surge-voltage and malfunction of HVIC.
5. All the filter capacitors should be connected close to JSMSEMI IPM, and they should have good characteristics for rejecting highfrequency ripple current.

## Package Information

### SOP-23H



LAND PATTERN RECOMMENDATIONS

## Revision History

| Rev. | Change          | Date      |
|------|-----------------|-----------|
| V1.0 | Initial version | 9/12/2021 |
|      |                 |           |

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